High Performance Bus Interface Solutions

MTBF (Mean Time Between Failures)

MTBF information for various General Standards products is included below. If you do not see the product you are interested in, please contact the factory.

PCIe-SIO4BX2-SYNC:

Failure rate: (FPMH) = 5.6686 MTBF = 1.7641E+05hrs Ambient temp: 30 C

Calculated at MIL-HDBK-217F Environment: Ground Benign

VME-SIO4A:

Failure rate: (FPMH) = .457743 MTBF = 2,184,631 hrs Ambient temp: 30 C

Calculated at MIL-HDBK-217F Environment: Ground Benign

CPCI3U64-HVDO16MI:

Failure rate: (FPMH) = 1.9855 MTBF = 5.0365E+05hrs Ambient temp: 30 C Calculated at MIL-HDBK-217F

Calculated at MIL-HDBK-217F Environment: Ground Benign

OPTO32:

Failure rate: (FPMH) = 2.6725 MTBF = 3.7418E+05hrs Ambient temp: 30 C Calculated at MIL-HDBK-217F

Calculated at MIL-HDBK-21/I Environment: Ground Benign

CPCI6U64-HVDOTP16MI:

Failure rate: (FPMH) = 3.2526 MTBF = 3.0745E+05 Ambient temp: 30 C

Calculated at MIL-HDBK-217F Environment: Ground Benign

CCPMC-16Al32SSA:

Failure rate: (FPMH) = 4.0571 MTBF = 2.4648E+05hrs Ambient temp: 30 C

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PMC-SIO4BX-4KLC:

Failure rate: = 1,383.364130

MTBF = 722,855Ambient temp: 30 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

24DSI16WRC:

Failure rate: (FPMH) = 3.8986 MTBF = 2.5650E + 05hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

cPCI6U64-24DSI20C500K:

Failure rate: (FPMH) = 2.8018 MTBF = 3.5692E + 05hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

16AO20:

Failure rate: (FPMH) = 4.0571 MTBF = 2.4648E + 05hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

PCI-HPDI32A-485-256K:

Failure rate: (FPMH) = 6.909599

MTBF = 144,726 hrs Ambient temp: 25 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

66-16AI32SSC:

Failure rate: (FPMH) = 1.9114 MTBF = 5.2318E+05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

CCPMC66-16Al32SSA:

Failure rate: (FPMH) = 2.6069 MTBF = 3.8359E + 05 hrsAmbient temp: 30 C

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CPCI6U64-16AIF16MIWR:

Failure rate: (FPMH) = 4.5330 MTBF = 2.2060E+05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

CPCI6U64-16AISS8AO8MI:

Failure rate: (FPMH) = 4.3820 MTBF = 2.2821E+05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

CPCI6U64-16AO16MI:

Failure rate: (FPMH) = 4.7935 MTBF = 2.0861E+05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F Environment: Ground Benign

CPCI6U-24DSI32R:

Failure rate: (FPMH) = 18.7050 MTBF = 5.3462E+04 hrs Ambient temp: 30 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

PCI SIO8BXS:

Failure rate: (FPMH) = .545100MTBF = 1.8340E + 05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

PCIe4 to PMC Adapter:

Failure rate: (FPMH) = 1.289234

MTBF = 775,654 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

PCIe4-PMC-1:

Failure rate: (FPMH) = 2.9641 MTBF = 3.3737E + 05 hrsAmbient temp: 30 C

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PCIe-16AI64SSA-64-50M-50K:

Failure rate: (FPMH) = 7.3242 MTBF = 1.3653E + 0.5 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

PCIe-16HSDI6:

Failure rate: (FPMH) = 2.1410 MTBF = 4.6708E + 05hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

PCIe to PMC Adapter:

Failure rate: (FPMH) = 1.8382 MTBF = 5.4401E+05 hrsAmbient temp: 30 C Calculated at MIL-HDBK-217F **Ground Benign**

PCIe OPTO32C-12V-Contact:

Failure rate: (FPMH) = 2.6725

MTBF = 37,418 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

PMC66-16AO16-12-F100-DF-49.152Mhz:

Failure rate: (FPMH) = 4.6051 MTBF = 2.1715E+05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

PMC66-16AISS8AO4:

Failure rate: (FPMH) = 4.4325 MTBF = 2.2560E + 05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

PMC66-SIO4BXR:

Failure rate: (FPMH) = 1.2317 MTBF = 8.1190E+05 hrs Ambient temp: 30 C

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PMC-12AISS8AO4-8-64K:

Failure rate: (FPMH) = 5.0717 MTBF = 1.9717E + 05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

PMC-16AIO168:

Failure rate: (FPMH) = 6.029887

MTBF = 1.6584E + 05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

PMC 24DSI12-8:

Failure rate: (FPMH) = .326655 MTBF = 3.06133+E05 hrs Ambient temp: 30 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

XMC-SIO4BX:

Failure rate: (FPMH) = 58.3878 MTBF = 1.7127+E05 hrs Ambient temp: 30 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

CPCI-16AO16:

Failure rate: (FPMH) = 3.5160

MTBF = 284,399 hrs Ambient temp: 25 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

PC104P-24DSI12:

Failure rate: (FPMH) = 4.2880

MTBF = 233,201 hrsAmbient temp: 25 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

PCI-12AIO:

Failure rate: (FPMH) = 1.3917

MTBF = 718,504 hrsAmbient temp: 25 C

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PCI-16AIO-41:

Failure rate: (FPMH) = 5.9328

MTBF = 168,553 hrsAmbient temp: 25 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

PCI-16AO12:

Failure rate: (FPMH) = 3.5161

MTBF = 284,399 hrsAmbient temp: 25 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

PCI-16HSDI:

Failure rate: (FPMH) = 5.3212

MTBF = 187,926 hrs Ambient temp: 25 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

PCI-SIO4B-SYNC:

Failure rate: (FPMH) = 3.2374

MTBF = 308,890 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

PMC-16AO4MF:

Failure rate: (FPMH) = 2.7237

MTBF = 367,145 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

PMC-SIO4BX:

Failure rate: (FPMH) = 1.3833

MTBF = 722,875 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

PCIe-16AI64SSC:

Failure rate: (FPMH) = 1.9114 MTBF = 5.2318E + 05 hrs

Ambient temp: 30 C

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PMC to cPCI Adapter

Failure rate: (FPMH) = .3740 MTBF = 2.6736E + 06 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment:** Ground Benign

PMC SIO4-64K

Failure rate: (FPMH) = 2.9868

MTBF = 334,801 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F Environment: Ground Benign

CCPMC-24DSI8R-8-SF-RUG

Failure rate: (FPMH) = 4.4396 MTBF = 2.2525E+05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

PNL-BNC-2x16AO16-SE

Failure rate: (FPMH) = .1535MTBF = 6.5156E+06 hrs Ambient temp: 30 C

Calculated at MIL-HDBK-217F **Environment:** Ground Benign

PNL-BNC-2x16Al64SSC-DF

Failure rate: (FPMH) = .0347MTBF = 2.8823E+06 hrs Ambient temp: 30 C

Calculated at MIL-HDBK-217F **Environment:** Ground Benign

PCIe 20AO8C500K

Failure rate: (FPMH) = 4.2764MTBF = 2.3384E + 05 hrsAmbient temp: 30 C

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PCIe 24DSI32

Failure rate: (FPMH) = 12.9861

MTBF = 7.7005E + 04 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment**: Ground Benign

PCIe 24DSI6LN

Failure rate: (FPMH) = 1.5440MTBF = 6.4767E + 05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment**: Ground Benign

SIO4BX

Failure rate: (FPMH) = 1.3833

MTBF = 722,875 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment**: Ground Benign

HPDI32A-COS

Failure rate: (FPMH) = 1.2792MTBF = 7.8176E + 05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment**: Ground Benign

PMC66-16LI8CLO4

Failure rate: (FPMH) = 1.5167MTBF = 6.5931E + 05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment**: Ground Benign

PMC to PCI Adapter

Failure rate: (FPMH) = 1.5723 MTBF = 4.5501E + 05 hrsAmbient temp: 30 C

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PMC OPTO32D

Failure rate: (FPMH) = 2.3163MTBF = 4.3172E + 05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment:** Ground Benign

OPTO32A

Failure rate: (FPMH) = .4998 MTBF = 2.0009E + 06 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment:** Ground Benign

PMC66-16AO16-12-F100-DF-49.152Mhz:

Failure rate: (FPMH) = 4.6051 MTBF = 2.1715E + 05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment:** Ground Benign

66-18AI32SSC1M:

Failure rate: (FPMH) = 1.7519 MTBF = 5.7082E + 05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment**: Ground Benign

PMC66-16AO16

Failure rate: (FPMH) = 4.6051 MTBF = 2.1715E+05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment: Ground Benign**

PMC-24CDS16LN

Failure rate: (FPMH) = 3.2265 MTBF = 3.1613E + 05 hrsAmbient temp: 30 C

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PCIe-16AO64C-32D-BP-F3-49.152M-0-0|

ailure rate: (FPMH) = 4.6640MTBF = 2.1441E+05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment:** Ground Benign

PMC66-24DSI6C500k

Failure rate: (FPMH) = 1.1599MTBF = 8.6214E + 05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment:** Ground Benign

PMC66-16AI64SSC-64-50.000M-LL

Failure rate: (FPMH) = 1.8534 MTBF = 5.3581E + 05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment:** Ground Benign

PCI OPTO32B-12V-CONTACT:

Failure rate: (FPMH) = 2.6725

MTBF = 37,418 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment:** Ground Benign

PCI OPTO32B-12V-CONTACT-8x28:

Failure rate: (FPMH) = 2.8257

MTBF= 35,209 hrs Ambient temp: 30C

Calculated at MIL-HDBK-217F **Environment:** Ground Benign

PCI 16SDI HS4:

Failure rate: (FPMH) = 5.321 MTBF = 1.8792E + 05 hrsAmbient temp: 30 C

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PMC-DIO24:

Failure rate: (FPMH) = 2.5989MTBF = 3.8477E + 05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment**: Ground Benign

PCI-DIO24:

Failure rate: (FPMH) = 2.5989 MTBF = 3.8477E + 05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment**: Ground Benign

PCI-16SDI-HS4:

Failure rate: (FPMH) = 5.1322 MTBF = 2.8972E + 05hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment:** Ground Benign

66-16HSDI4AO4:

Failure rate: (FPMH) = 4.9926MTBF = 2.0030E + 05hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment:** Ground Benign

PMC-16AIO-41

Failure rate: (FPMH) = 6.3275

MTBF = 153,497 hrs Ambient temp: 20 C

Calculated at MIL-HDBK-217F **Environment:** Ground Benign

PCIe-SIO4BX2:

Failure rate: (FPMH) = 5.6606MTBF = 1.7666E + 05hrsAmbient temp: 30 C

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PCIe-SIO4BX2-X:

Failure rate: (FPMH) = 5.6606 MTBF = 1.7666E+05hrs Ambient temp: 30 C

Calculated at MIL-HDBK-217F **Environment**: Ground Benign

PCIe-HPDI32B-COS-32K

Failure rate: (FPMH) = 1.2375 MTBF = 7.7246E+05 hrs Ambient temp: 30 C

Calculated at MIL-HDBK-217F **Environment:** Ground Benign

CCPMC66-16AICS32R:

Failure rate: (FPMH) = 2.3275 MTBF = 3.7461E+05 hrs Ambient temp: 30 C

Calculated at MIL-HDBK-217F **Environment:** Ground Benign

PMC ADADIO-311

Failure rate: (FPMH) = 2.0890

MTBF = 4.7870E+05hrs Ambient temp: 30 C

Calculated at MIL-HDBK-217F **Environment:** Ground Benign

PMC-HPDI32B-256K-P1-L3SFB Failure rate: (FPMH) = 43.8884

MTBF = 2.2785E+04hrs Ambient temp: 30 C

Calculated at MIL-HDBK-217F **Environment:** Ground Benign

PCI66-SIO4B-256K

Failure rate: (FPMH) = 6.2263 MTBF = 1.6061E+05 HRS Ambient temp: 30 C

Calculated at MIL-HDBK-217F **Environment:** Ground Benign

PMC 16AI64-2

Failure rate: (FPMH) = 2.8851 MTBF = 3.4661E+05 hrs Ambient temp: 30 C

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PMC SIO4AR-256K

Failure rate: (FPMH) = 1.9500 MTBF = 5.1282E + 05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment:** Ground Benign

PCIe-24DSI64C200K-32-10V-500K-SRF-0

Failure rate: (FPMH) = 11.9173

MTBF = 8.397E + 04 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment:** Ground Benign

PCIe-OPTO16x16-5V

Failure rate: (FPMH) = 2.2967MTBF = 4.3542E + 05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment:** Ground Benign

PCIe-OPTO16x16-12V

Failure rate: (FPMH) = 2.2967MTBF = 4.3542E + 05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment:** Ground Benign

66-16AISS16AO2-16-2-45.00M

Failure rate: (FPMH) = 4.0922MTBF = 2.4437E + 05 hrs

Calculated at MIL-HDBK-217F **Environment:** Ground Benign

Ambient temp: 30 C

PCIE-16AO64C-16D-BP-F1-49.152M-0-0

Failure rate: (FPMH) = 4.6640

MTBF = 2.1441E+05 hrsAmbient temp: 30 C

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CCVPX-16AO16C

Failure rate: (FPMH) = 4.7148 MTBF = 2.2415E+05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment:** Ground Benign

CCVPX-16AI32SSC1M

Failure rate: (FPMH) = 1.9647MTBF = 5.2621E + 05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment:** Ground Benign

CCVPX-16AISS8AO4C

Failure rate: (FPMH) = 4.6245MTBF = 2.5420E+05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment:** Ground Benign

PMC66-SIO4BXR-L3RIO

Failure rate: (FPMH) = 1.2317 MTBF = 8.1190E + 05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment:** Ground Benign

PCIE-16AO64C-64SBP-F3-49.152M-OD-0

Failure rate: (FPMH) = 4.6640MTBF = 2.1441E+05 hrsAmbient temp: 30 C

Calculated at MIL-HDBK-217F **Environment:** Ground Benign

PCIE-DIO32A-S

Failure rate: (FPMH) = 3.4978 MTBF = 3.7783E + 05 hrsAmbient temp: 30 C

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Development of MTBF Values:

The most widely known and used reliability prediction handbook is Mil-217. It is used by both commercial companies and the defense industry, and is accepted and known world-wide. The most recent revision is "Military Handbook, Reliability Prediction of Electronic Equipment", MIL-HDBK-217, Revision F, Notice 2, which was released in February of 1995. It contains failure rate models for numerous electronic components such as integrated circuits, transistors, diodes, resistors, capacitors, relays, switches, and connectors, to name a few. MIL-217 requires a greater amount data entered into the model. It also is a little harsher in the calculation of failure rate data than the Bellcore standard. Typically, but not always, MIL-217 calculated results will show a higher failure rate than Bellcore standard for the same system. This difference in the standards obviously stems from the original intended use of the MIL-217 standard for aerospace and military, or mission critical applications.

Maintaining reliability and providing reliability engineering is an essential need with modern electronic systems. Reliability engineering for electronic equipment requires a means for a quantitative baseline, or a reliability prediction analysis. The MIL-217 standard was developed for military and aerospace applications; however, it has become widely used for industrial and commercial electronic equipment applications throughout the world. Using the Mil-217 standard for reliability prediction produces calculated Failure Rate and Mean Time Between Failures (MTBF) numbers for the individual components, equipment and the overall system. The final calculated prediction results are based on the roll-up, or summation, of all the individual component failure rates.